502669784 02/06/2014

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2716391

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
UNNIKRISHNAN VADAKKANMARUVEEDU	11/26/2013
ZENGHUI ZHAO	11/26/2013
VINAY MITTER	11/20/2013
ROY SILVERSTEIN	11/20/2013
ANKUR JAIN	11/26/2013
JON ANDERSON	12/05/2013

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED		
Street Address:	5775 MOREHOUSE DRIVE		
City:	SAN DIEGO		
State/Country:	CALIFORNIA		
Postal Code:	92121		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13918962

CORRESPONDENCE DATA

Fax Number: (770)804-0900 **Phone**: 678-361-4915

Email: swigmore@srtslaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: SMITH RISLEY TEMPEL SANTOS LLC

Address Line 1: TWO RAVINIA DRIVE

Address Line 2: SUITE 700

Address Line 4: ATLANTA, GEORGIA 30346

ATTORNEY DOCKET NUMBER: 17006.0192U1 (131864)

PATENT

502669784 REEL: 032161 FRAME: 0186

NAME OF SUBMITTER:	STEVEN P. WIGMORE, REG. NO. 40,447	
Signature: /SPW/		
Date:	02/06/2014	
Total Attachments: 5 source=131864_17006_0192U1_Signed_ASSIGNMENT_AS_FILED_FEB_6_2014#page1.tif source=131864_17006_0192U1_Signed_ASSIGNMENT_AS_FILED_FEB_6_2014#page2.tif source=131864_17006_0192U1_Signed_ASSIGNMENT_AS_FILED_FEB_6_2014#page3.tif source=131864_17006_0192U1_Signed_ASSIGNMENT_AS_FILED_FEB_6_2014#page4.tif source=131864_17006_0192U1_Signed_ASSIGNMENT_AS_FILED_FEB_6_2014#page5.tif		

ASSIGNMENT

WHEREAS, WE,

- 1. UNNIKRISHNAN VADAKKANMARUVEEDU, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Phoenix, Arizona,
- 2. **ZENGHUI ZHAO**, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California,
- 3. **VINAY MITTER**, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California,
- 4. **ROY SILVERSTEIN**, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California,
- 5. **ANKUR JAIN**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California, and
- 6. **JON ANDERSON**, a citizen of the United States, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Boulder, Colorado, have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to SYSTEM AND METHOD FOR ESTIMATING AMBIENT TEMPERATURE OF A PORTABLE COMPUTING DEVICE USING A VOICE COIL (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/918,962 filed June 16, 2013, Qualcomm Reference No. 131864, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or

filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	San Degli,	on 11 26/203 3 UNNI	KRISHNAN VADAKKANMARUVEEDU
Done at	Sun Diego.	on 11/26/2013	ZENGHUI ZHAO
Done at	LOCATION)	on $\frac{\sqrt{76}\sqrt{20}^2}{\text{DATE}}$	VINAX MITTER
Done at	LOCATION	onDATE	ROY SILVERSTEIN
Done at §	LOCATION	on <u>11 26/2018</u> DATE	WKUR JAIN
Done at	LOCATION	, on	JON ANDERSON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		
************************************	LOCATION		DATE	UNNIKRISHNAN VADAKKANMARUVEEDU
Done at_	LOCATION	, on	DATE	ZENGHUI ZHAO
Done at _	LOCATION	, on	DATE	VINAY MITTER
Done at \(\int \)	ADIA, CA	_, on _	11/20/13	Hot Silverstein
	250000			0
Done at _	LOCATION	_, on _	DATE	ANKUR JAIN
Done at	LOCATION	, on	DATE	JON ANDERSON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Y	, on		UNNIKRISHNAN VADAKKANMARUVEEDU
	LOCATION		DATE	UNNIKRISHNAN VADAKKANMARUVEEDU
Done at _	LOCATION	, on	DATE	ZENGHUI ZHAO
Done at _	LOCATION	, on	DATE	VINAY MITTER
Done at	LOCATION	, on	DATE	ROY SILVERSTEIN
Done at_	LOCATION	, on	DATE	ANKUR JAIN
	() LO CO LOCATION			01/1/

PATENT REEL: 032161 FRAME: 0192

RECORDED: 02/06/2014